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Part Number: 07	736441016	
	ctive	
Description: HD	<u>DM Backplane Connector System</u> DM Board-to-Board Backplane Header, Vertical, SMC, Press-Fit, Guide Post Location Polarizing Key Position N/A, 144 Circuits, Mating Length 5.00mm	
Documents:		
Drawing (PDF)	Packaging Specification PK-70873-0818-001 (PDF)	TTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTTT
3D Model	RoHS Certificate of Compliance (PDF)	
3D Model (PDF)		
		Series image - Reference only
Agency Certification		
CSA	LR19980	EUELV
UL	E29179	Not Relevant
General		EU RoHS China RoHS
Product Family	Backplane Connectors	Compliant
Series	<u>73644</u>	REACH SVHC
Application	Backplane	Not Contained Per -
Comments	Standard Press-Fit	D(2020)9139-DC (19
Component Type	PCB Header	Jan 2021)
Overview	HDM Backplane Connector System	Halogen-Free
Product Name	HDM	Status
UPC	800754345231	Low-Halogen
Physical		For more information, please visit Contact US
Physical Circuits (Loaded)	144	China ROHS Green Image
Circuits (maximum)	144	ELV Not Relevant
Color - Resin	Black, Natural	RoHS Phthalates Not Contained
Durability (mating cycles n		
First Mate / Last Break	, No	
Flammability	94V-0	
Guide to Mating Part	Yes	Search Parts in this Series
Keying to Mating Part	None	73644 Series
Material - Metal	Phosphor Bronze, Stainless Steel	
Material - Plating Mating	Gold	Mates With
Material - Plating Terminat	tion Gold	73632 HDM+ Board-to-Board Daughtercar
Material - Resin	High Temperature Thermoplastic	Receptacle. <u>73780</u> HDM Board-to-Board
Net Weight	9.026/g	Daughtercard Receptacle
Number of Columns	24	
Number of Pairs	Open Pin Field	Application Tooling FAQ
Number of Rows	6	Tooling specifications and manuals are
Orientation	Vertical	found by selecting the products below.
PC Tail Length	3.50mm	Crimp Height Specifications are then
PCB Locator	No	contained in the Application Tooling
PCB Retention	Yes	Specification document.
PCB Thickness - Recomm		Global
Packaging Type	Tube	Description Product #
Pitch - Mating Interface	2.00mm	Extraction Tool <u>621001000</u>
Pitch - Termination Interfa		·
Plating min - Mating	0.762µm	
Plating min - Termination	0.051µm	
Polarized to PCB	No	
Stackable	Yes	
Surface Mount Compatible		
Temperature Range - Ope	•	
Termination Interface: Styl	le Through Hole - Compliant Pin	

Electrical	
Current - Maximum per Contact	1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC
Solder Process Data	
Lead-freeProcess Capability	N/A
Material Info	
Reference - Drawing Numbers	
Packaging Specification	PK-70873-0818-0
Sales Drawing	SD-73644-004-00

PK-70873-0818-001 SD-73644-004-001, SDA-73644-XXXX-001, SDA-73644-XXXX-002

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